



# Mag Layers USA, INC

## Specification Sheet

P/N : **GMLB-160808-Series-SJ-RU**

### Products:

[Molded Power Chokes](#)

[Multilayer Chip Inductors](#)

[Lan Transformer](#)

[RF Passive / Antennas](#)

[Automotive](#)

### Certifications:

[ISO9001](#)

[IATF16949](#)

[ISO14001](#)

[QC080000](#)

### US Office

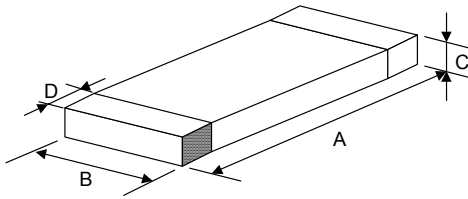
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[www.maglayersusa.com](http://www.maglayersusa.com)  
[info@maglayersusa.com](mailto:info@maglayersusa.com)



## PRODUCT DIMENSION

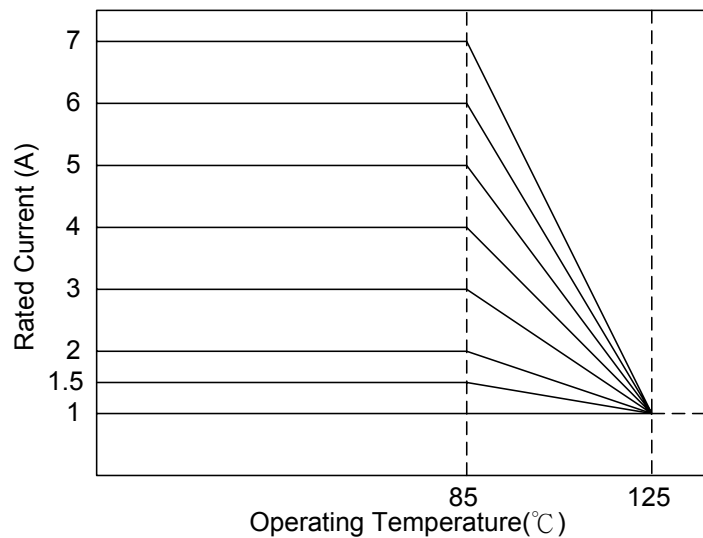


NOTE : Dimensions in mm

PRODUCT NO.	A	B	C	D
GMLB-160808 (0603)	1.6±0.15 (0.063±0.006)	0.8±0.15 (0.031±0.006)	0.8±0.15 (0.031±0.006)	0.3±0.20 (0.012±0.008)

## CURRENT DERATING

In operating temperatures exceeding +85°C, derating of current is necessary for chip ferrite beads for which rated current is 1.5A or over. Please apply the derating curve shown below according to the operating temperature.



## ELECTRICAL REQUIREMENTS

Part Number	Impedance ( $\Omega$ ) at 100 MHz	R <sub>DC</sub> ( $\Omega$ ) Max.	I <sub>DC</sub> (mA) Max.	Operating Temp. Range ( $^{\circ}\text{C}$ )
GMLB-160808-0030Y-SJ-RU	30 $\pm$ 25%	0.20	400	-55 ~ +125
GMLB-160808-0040Y-SJ-RU	40 $\pm$ 25%		300	
GMLB-160808-0060Y-SJ-RU	60 $\pm$ 25%	0.40		
GMLB-160808-0080Y-SJ-RU	80 $\pm$ 25%			
GMLB-160808-0100Y-SJ-RU	100 $\pm$ 25%			
GMLB-160808-0120Y-SJ-RU	120 $\pm$ 25%	0.50		
GMLB-160808-0180Y-SJ-RU	180 $\pm$ 25%			
GMLB-160808-0220Y-SJ-RU	220 $\pm$ 25%			
GMLB-160808-0240Y-SJ-RU	240 $\pm$ 25%			
GMLB-160808-0300Y-SJ-RU	300 $\pm$ 25%	0.70	150	
GMLB-160808-0450Y-SJ-RU	450 $\pm$ 25%			
GMLB-160808-0600Y-SJ-RU	600 $\pm$ 25%	1.00	100	
GMLB-160808-1000Y-SJ-RU	1000 $\pm$ 25%		200	
GMLB-160808-1200Y-SJ-RU	1200 $\pm$ 25%			
GMLB-160808-1500Y-SJ-RU	1500 $\pm$ 25%			

- Temperature rise should be less than 40 $^{\circ}\text{C}$  for P-type and less than 25 $^{\circ}\text{C}$  for other types when rated current is applied.

## MEASURING METHOD / CONDITION

- Test Instrument:

Z: Agilent 4291B Impedance Analyzer, Test Fixture: Agilent 16192

Osc. Level: 500mV

R<sub>DC</sub>: Agilent 34401A

- Test Condition:

< Unless otherwise specified >

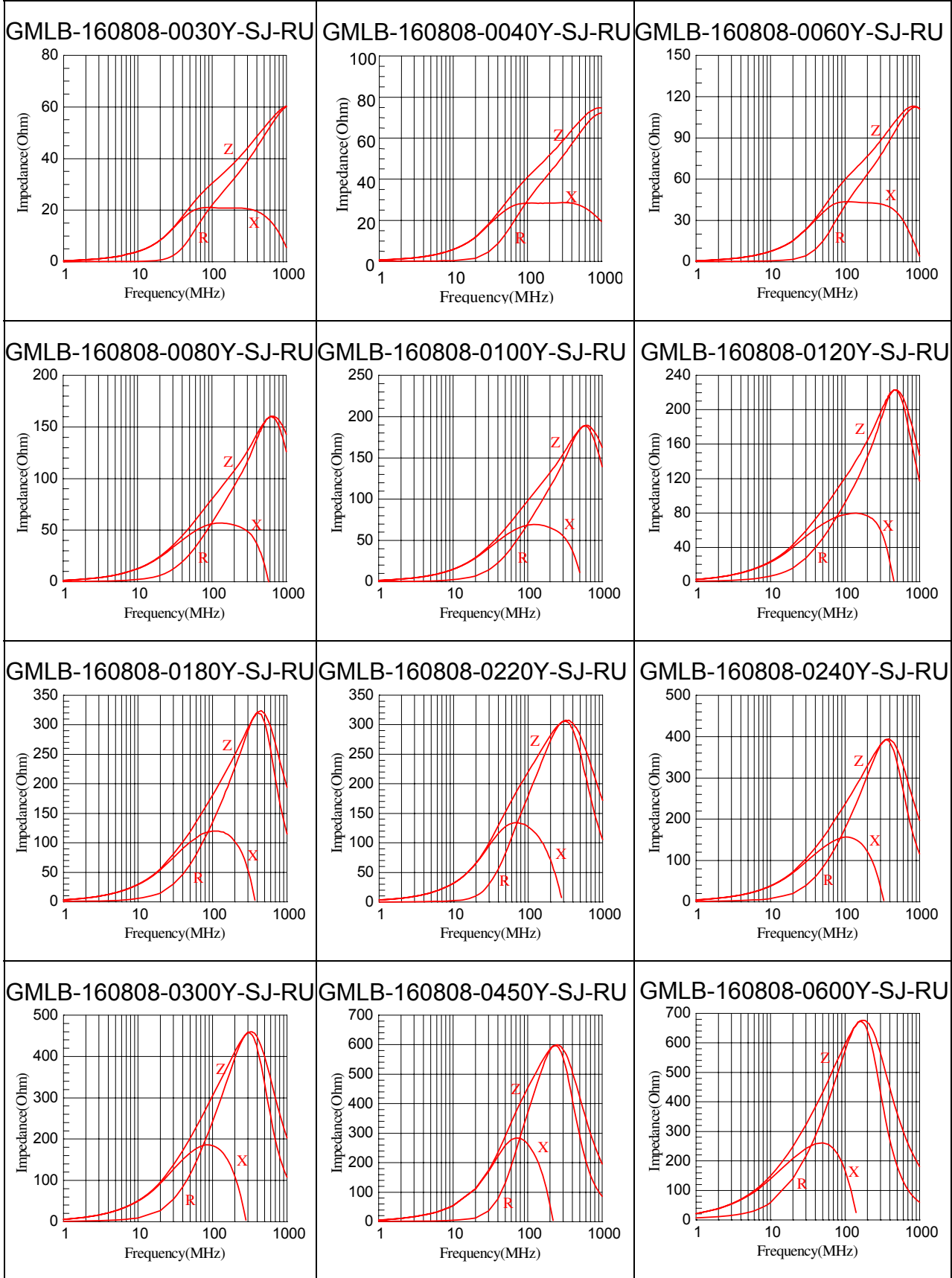
Temperature: 15 $^{\circ}\text{C}$  to 35 $^{\circ}\text{C}$  Humidity: 25% to 85% RH

< In case of doubt >

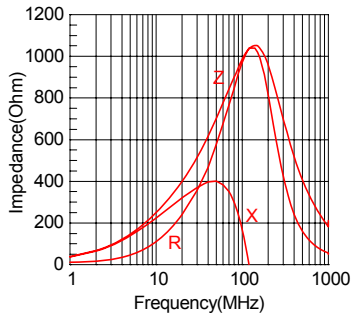
Temperature: 25 $^{\circ}\text{C} \pm 2^{\circ}\text{C}$  Humidity: 60% to 70% RH



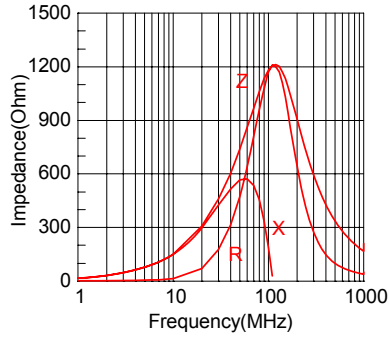
# TYPICAL ELECTRICAL CHARACTERISTICS ( T=25°C)



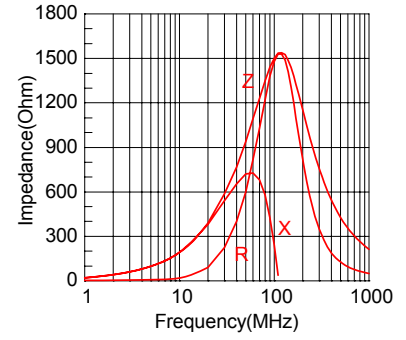
GMLB-160808-1000Y-SJ-RU



GMLB-160808-1200Y-SJ-RU

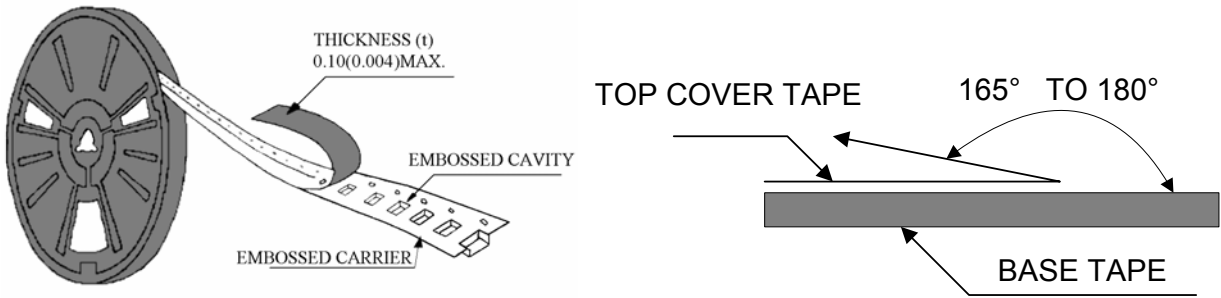


GMLB-160808-1500Y-SJ-RU



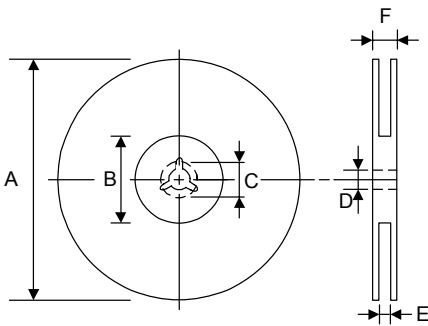
## PACKAGING

### ● Peel-off Force

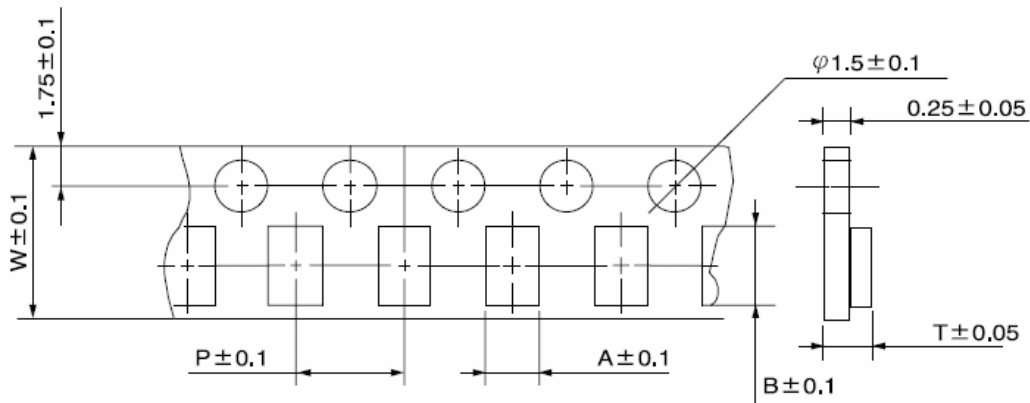


The force for peeling off cover tape is 10 grams in the arrow direction.

### ● Dimension (Unit: mm)

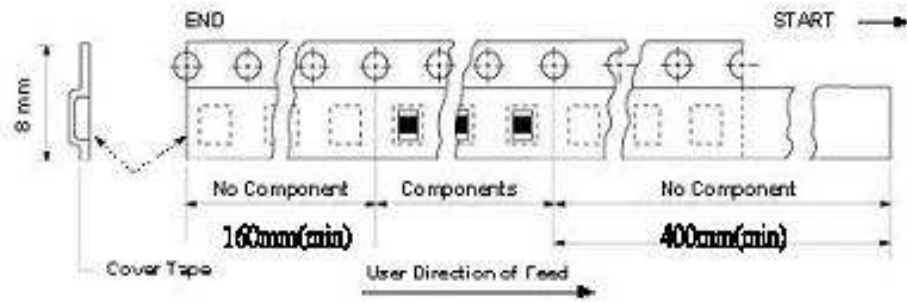


TYPE	A	B	C	D	E	F
8 mm	178±1	60 +0.5 -0	-	13 ±0.2	9 ±0.5	12 ±0.5
12 mm	178±0.3	60 ±0.2	19.3 ±0.1	13.5 ±0.1	13.6 ±0.1	-



TYPE	SIZE	A	B	W	P	T	CHIPS/REEL
GMLB	160808	1.1	1.9	8	4	1.1, *0.95±0.05	4000

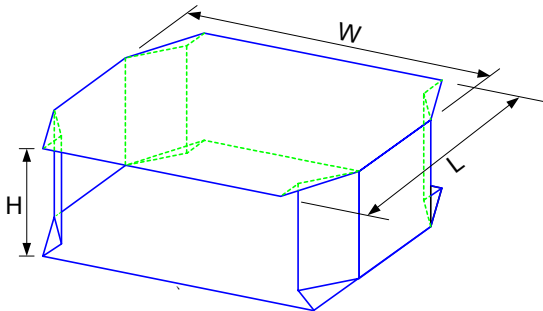
\*: For paper reels



● Taping Quantity

<b>SERIES</b>	<b>1608</b>
PCS/Reel	4000

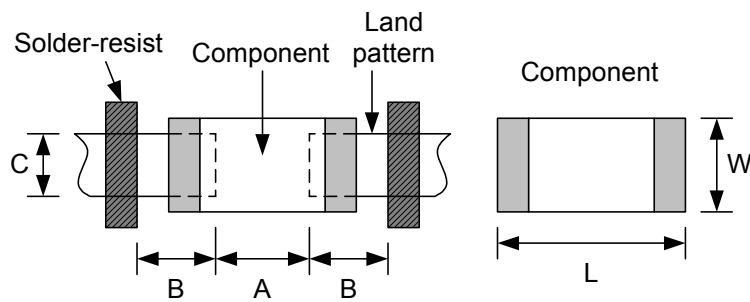
● Tape Packing Case



No. of Reels	W	L	H
2	18±0.5	18±0.5	2.4±0.2
3	18±0.5	18±0.5	3.6±0.2
4	18±0.5	18±0.5	4.8±0.2
5	18±0.5	18±0.5	6.0±0.2

Unit: cm

■ **RECOMMENDED PCB LAYOUT**

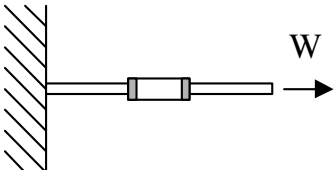
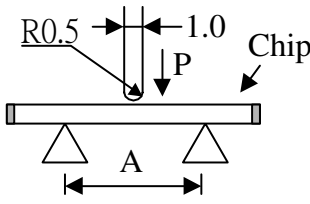


Unit: mm

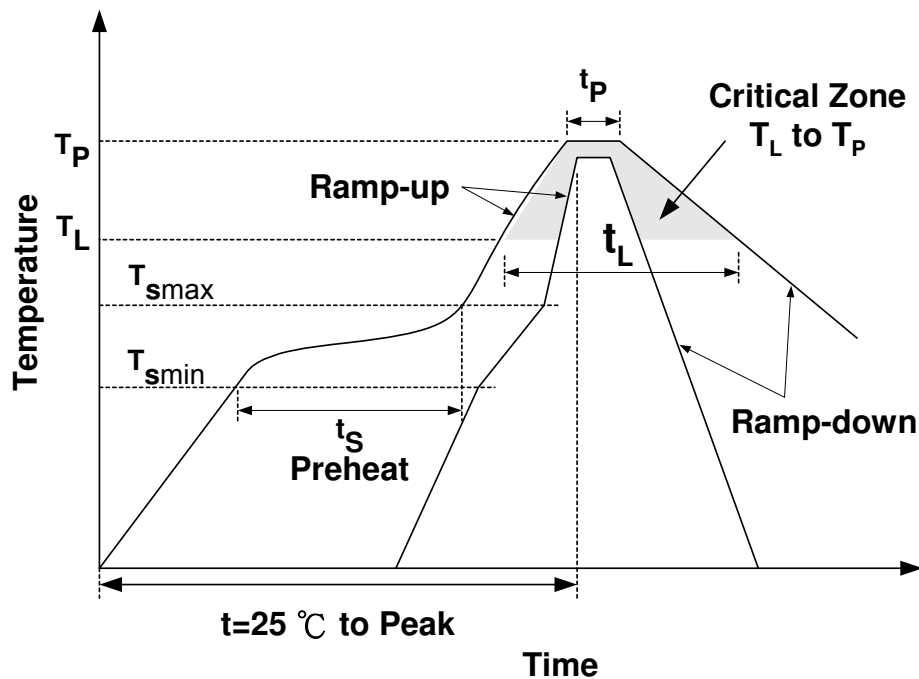
Type	1608	
Size	L	1.6
	W	0.8
A	0.6~0.8	
B	0.6~0.8	
C	0.6~0.8	



## RELIABILITY TEST

•Mechanical Performance Test				
ITEM	SPECIFICATION	TEST CONDITION		
Solderability	More than 90% of the terminal electrode shall be covered with fresh solder.	Solder: Sn-3.0Ag-0.5Cu Solder Temperature: 245 ± 5°C Flux: Rosin Dip Time: 3 ± 1 Seconds		
Soldering Heat Resistance	The chip shall not crack. More than 75% of the terminal electrode shall be covered with solder.	Solder temperature : 260 ± 5°C Flux: Rosin Dip time: 10 ± 1 seconds		
Terminal Strength	The terminal electrode shall not be broken off nor the ferrite damaged.  	TYPE	W(KGF)	TIME (SEC)
		GMLB-160808	0.6	30 ± 5
Bending Strength	No mechanical damage. The ferrite shall not be damaged.  	TYPE	A(MM)	P(KGF)
		GMLB-160808	1.0	1.0
• Climatic test				
ITEM	SPECIFICATION	TEST CONDITION		
Thermal Shock (Temperature Cycle)	Impedance shall be within ± 20% of the initial value.	Temperature: -55°C~125°C for 30 minutes each, 100 cycles.		
Humidity Resistance		Temperature : 60°C Humidity: 95% RH Time: 1000 ± 12 Hours		
High Temperature Resistance		Temperature : 85°C±2°C Time: 1000 ± 12 Hours		
1. Operating Temperature Range: -55 °C TO +125°C 2. Storage Condition: The temperature should be within -40°C~85°C and humidity should be less than 75% RH. The product should be used within 6 months from the time of delivery.				

## RECOMMENDED REFLOW SOLDERING PROFILE



Profile Feature		Sn-Pb	Pb-Free
Preheat	$t_s$	60~120 seconds	60~180 seconds
	$T_{smin}$	100°C	150°C
	$T_{smax}$	150°C	200°C
Average ramp-up rate ( $T_{smax}$ to $T_P$ )		3°C/second max.	3°C/second max.
Time main above	Temperature ( $T_L$ )	183°C	217°C
	Time ( $t_L$ )	60~150 seconds	60~150 seconds
Peak temperature ( $T_P$ )		230°C	250~260°C
Time within 5°C of actual peak temperature ( $t_p$ )		10 seconds	10 seconds
Ramp-down rate		6°C/sec max.	6°C/sec max.
Time 25°C to peak temperature		6 minutes max.	8 minutes max.

## NOTES

The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.